

Doc #: SPIRE-RAL-DWG-000646 Issue: 4.8 Date: 30th September 2002 Page 1 of 8

	Subject:	SPIRE BLOCK DIA	GRAM
PREPARED BY:	J. DELDERFIELD		Date:
APPROVED BY:	K. KING		Date:



Doc #: SPIRE-RAL-DWG-000646

Issue: 4.8
Date: 30th September 2002
Page 2 of 8

CHANGE RECORD

ISSUE	DATE	CHANGE(S) MADE				
2.0	7/6/01	First Controlled Issue after IIDR				
2.1	18/6/01	Deleted S/C Synchronisation.				
		Added Master Clock Lines				
		Split FCU into Modules, avoiding mixing Prime and Redundant connections vame motherboard, and requiring BSM module to be split Prime/Redundant, TBC.				
		Re-ordered signal channels into harnesses to get breaks between BDAs to better align with LIA divisions.				
		Removed last vestages of showing Fast and Slow I/Fs separately as they are linked by W1-W6.				
		Fix FCU J26 duplication.				
2.2	29/6/01	Put BDA connector numbers in line with JPL's that indicate which of the six geometric positions are used.				
		Bundle back-harness wires as per JPL diagram.				
2.2	7/7/01	Define LCL names.				
2.3	7/7/01	Rearrange JFETs to stress "modularity"				
2.4	7/8/01	Increase FCU J21 and J22 to 25wayto take calibrator heater wires that were omitted.				
		Swop JFETs to using 37way filters with partially populated contacts.				
2.5	8/8/01	Put in FPU clamshell connectors as harness name "breaks". Delete TBD.				
2.6	7/9/01	Update SMEC connectors on FPU from 50 way to 2x37way each side.				
2.7	9/10/01	Put in fully updated HSFCU				
2.8	12/10/01	Correct way I harness tails split on to FCUin error in version 2.7				
		Remove branch from F12A and route 300mK temperature "detectors" via HSJFS J7 AND J8 and new F 28. Correct PMW BDA Allocation. Add note to F20 and F21 so clear that each has one "Cernox" that is actually a 300Mk heater.				
		Put in HSDCU with connectors drawn to scale.				
2.9	18/10/01	Correct errors with W3-6 labels that crept into issue 2.8				
3.0	30/10/01	Swop numbers on connector lines for DCU redundant bias generator so they fit with harness definition document, and connectors 29-34 remain if generators were to be put on one module or otherwise reconfigured.				
3.1	31/10/01	Remove Filter Modules from JFET racks, thus adopting JPL's intention to use filter connectors and spliced harness.				
3.2	9/11/01	Reduce HSDCU Bias module front panel sizes and house them in one double sided module. Call S4 T1 as per Doug's drawings.				
3.3	21/11/01	Add last few connector IDs to JFET racks.				
3.4	11/12/01	Got J1-J4 on FCU the correct way around [SCU to MCU!]				
3.5	18/12/01	Move Connectors around on HSFPU to match CEA's v0.5 HSFPU ICD.				
		Keep JTAG connectors shown elsewhere in DRCU ICD/Specbut renumber as				



SPIRE

INSTRUMENT BLOCK DIAGRAM

Doc #: SPIRE-RAL-DWG-000646

Issue: 4.8
Date: 30th September 2002
Page 3 of 8

		J37 and J38		
		Combine HSFCU SCU's DPU I/F and Cooler/Stimulus Modules		
		Re-jig Shutter DRCU connectors to not be wired via HSFCU Modules		
		Reduce J25/J26 Connector sizes as moving shutter wiring removes some pins from them.		
		Change 1553 buses to A & B rather than Prime & Redundant		
		Change J23 and J24 sizes because of HSFCU PCB frame restrictions.		
		Move HSFCU Connectors to be in correct physical layout.		
		Add J29 and J30 to shutter wiring to accommodate non-shutter launch latch confirm inputs. Change J15 and J16 to 25way as Doug's given the shutter more wires.		
		Change HSFPU Shutter J17 and J18 to 21way MDM to match.		
		Show power links on DRCU unit because these are not internal.		
		Update HSDCU Bias connectors J29/32 to use 78-way HD triple row connectors after their acceptance by ESA.		
3.6	20/12/01	Frederic's comments on J22 and 3TCs implemented.		
3.7	1/1/02	HSFCU Duplicate J29/30 Fixed, bumping numbers for JTAGs		
3.8	1/2/02	Change SCAL 21 ways to 37 ways.		
3.9	25/2/02	As per Passvogel decision, put four "skin" connectors on cryostat associated with cryoharnesses 10-13, to act as access points for EGSE for shutter operation and latch confirmations. Bracket on side of HSFCU deleted, and links to HCDMU's RTUs.		
		As HERSCHEL latest accommodation, add connector plate on top of SVM and change cryoharness to include extra/extended/external "E" sections, which are all 1:1 with CVV wall connectors to minimise external RF. loops (except skin connector functions as per above change). "I" harnesses become copper for flight.		
		Rationalise sex/sizes of HSFCU internal power connectors		
4.0	5/3/02	Route 300 mk temperature control via Harness 2 and not Harness 1 due to needing to keep spare pins on CVV connectors.		
4.1	12/4/02	Optimise alignment of drawing		
4.1	12/4/02	Correct HSFCU J9/10 & 31-36 shell size as per SVM meeting		
4.2	22/4./02	Change E harness category to I and I harness category to S(SVM) to be the same as PACS and HIFI.		
		Add caveat about using this diagram as a harness definition diagram		
		Show which one of each pair of cryoharness in-line connectors are chassis mounted by adding P/J notes along I/F lines		
		Include representation of 300mK cooling busbar and move 300mK sensor/heater unit to show how it links into F harnesses. Call this sub-system HSPTC (Photometer Temperature Control).		
		Move EGSE break-out connectors from CVV skin to SCM connector panel as Astrium design implements.		
4.3	15/5/02	Corrected one of two J33s to J34 on HSJFP		
		Updated BDA Nanonics J numberswhich define their positions		
		Move J22 link to SVM panel rather than in air above HSDCU.		
4.4	1/6/02	Remove connectors on SME because unfortunately only flying leads can be		
R-	-			



Doc #: SPIRE-RAL-DWG-000646 Issue: 4.8 Date: 30th September 2002 Page 4 of 8

		accommodated.
		Relabel Harness S4 Type 1a not Type 1 because of its small variation compared to other Type1s, i.e its link to S2.
		Add note to HSDCU J26 saying that this is the connector to which the 6spare SSW bolometer channels would go if they were wired through. They are actually terminated at HSDCU end of S2 with $15K\Omega$ resistors.
4.5	26/6/02	Shutter removed and thus launch latch SVM panel connectors simplified.
		37 and 78 way connector positions swopped on bias on HSDCU
4.6	9/7/02	Drawing re-arrangement of 28V Power wiring and HSFCU to HSDCU secondary feed cables to better represent recent upodate of DRCU ICDs. Not a hardware change.
		Sex of JTAG connectors on HSFCU changednot an external SPIRE I/F.
		Small changes to order of modules in HSFCU
		All connectors on HSFCU mating to cryoharness rotated 180° relative to view of unit face as drawnSPR-MX-5200 000 C
4.7	22/7/22	Corrected some S-harness tails on to HSFCU placed incorrectly in 4.6 changes
4.8	30/8/02	Change HSFCU J9/10/31/32 to be 25 pin not 15. HSFCU Internal harness.



Doc #: SPIRE-RAL-DWG-000646

Issue: 4.8
Date: 30th September 2002
Page 5 of 8

ACRONYM LIST

Term	Meaning				
ADC	Analogue to Digital Converter				
AIV	Assembly, Integration and Verification				
AME	Absolute Measurement Error				
AOCS	Attitude and Orbit Control System				
APART	Arizona's Program for the Analysis of Radiation Transfer				
APE	Absolute Pointing Error				
ASAP	Advanced Systems Analysis Program				
AVM	Avionics Model Avionics Model				
BDA	Bolometer Detector Array				
BFL	Back Focal Length				
BRO	Breault Research Organization				
BSM	Beam Steering Mirror				
CDMS	Command and Data Management System				
CDMU	Command and Data Management Unit				
CDR	Critical Design Review				
CMOS	Complimentary Metal Oxide Silicon				
CPU	Central Processing Unit				
CVV	Cryostat Vacuum Vessel				
DAC	Digital to Analogue Converter				
DAQ	Data Acquisition				
DCU	Detector Control Unit = HSDCU				
DPU	Digital Processing Unit = HSDPU				
DSP	Digital Signal Processor				
DQE	Detective Quantum Efficiency				
EDAC	Error Detection and Correction				
EGSE	Electrical Ground Support Equipment				
EMC	Electro-magnetic Compatibility				
EMI	Electro-magnetic Interference				
ESA	European Space Agency				
FCU	FCU Control Unit = HSFCU				
FIR	Far Infrared				
FIRST	Far Infra-Red and Submillimetre Telescope				
FOV	Field of View				
F-P	Fabry-Perot				
FPGA	Field Programmable Gate Array				
FPU	Focal Plane Unit				
FTS	Fourier Transform Spectrometer				
FWHM	Full Width Half maximum				
GSFC	Goddard Space Flight Center				
HK	House Keeping				
HOB	Herschel Optical Bench				
HPDU	Herschel Power Distribution Unit				
HSDCU	Herschel-SPIRE Detector Control Unit				
HSDPU	Herschel-SPIRE Digital Processing Unit				
HSFCU	Herschel-SPIRE FPU Control Unit				
HSO	Herschel Space Observatory				
IF	Interface				
IID-A	Instrument Interface Document - Part A				



SPIRE

INSTRUMENT BLOCK DIAGRAM

Doc #: SPIRE-RAL-DWG-000646

Issue: 4.8
Date: 30th September 2002
Page 6 of 8

Term	Meaning				
IID-B	Instrument Interface Document - Part B				
IMF	Initial Mass Function				
IR	Infrared				
IRD	Instrument Requirements Document				
IRTS	Infrared Telescope in Space				
ISM	Interstellar Medium				
JFET	Junction Field Effect Transistor				
ISO	Infrared Space Observatory				
LCL	Latching Current Limiter				
LIA	Lock-In Amplifier				
LVDT	Linear Variable Differential Transformer				
MAC	Multi Axis Controller				
LWS	Long Wave Spectrometer (an instrument used on ISO)				
MCU	Mechanism Control Unit = HSMCU				
M-P	Martin-Puplett				
NEP	Noise Equivalent Power				
NTD	Neutron Transmutation Doped				
OBS	On-Board Software				
OMD	Observing Modes Document				
OPD	Optical Path Difference				
PACS	Photodetector Array Camera and Spectrometer				
PCAL	Photometer Calibration source				
PID	Proportional, Integral and Differential (used in the context of feedback control loop architecture)				
PLW	Photometer, Long Wavelength				
PMW	Photometer, Medium Wavelength				
POF	Photometer Observatory Function				
PROM	Programmable Read Only Memory				
PSW	Photometer, Short Wavelength				
PUS	Packet Utilisation Standard				
RMS	Root Mean Squared				
SCAL	Spectrometer Calibration Source				
SCUBA	Submillimetre Common User Bolometer Array				
SED	Spectral Energy Distribution				
SMEC	Spectrometer Mechanics				
SMPS	Switch Mode Power Supply				
SOF	Spectrometer Observatory Function				
SPIRE	Spectral and Photometric Imaging Receiver				
SRAM	Static Random Access Memory				
SSSD	SubSystem Specification Document				
STP	Standard Temperature and Pressure				
SVM	Service Module				
TBC	To Be Confirmed				
TBD	To Be Determined				
TC	Telecommand				
URD	User Requirements Document				
UV	Ultra Violet				
WE	Warm Electronics				
ZPD	Zero Path Difference				



Doc #: SPIRE-RAL-DWG-000646

Issue: 4.8
Date: 30th September 2002
Page 7 of 8

DISTRIBUTION LIST

Institute	Holder	Issue/ Revision and Distribution Date							
		4.1	4.1 4.2 4.3 4.4 4.5 4.6 4.7 4.8						4.8
		12/4/02	22/4/02	15/5/02	01/06/02	26/06/02	09/07/02	22/08/02	30/9/02
RAL	Delderfield	X	X	X	X	X	X	X	Х
	Swinyard	X	X	X	X	X	X	X	Х
	Griffin	X	X	X	X	X	X	X	х
	Parker	X	X	X	X	X	X	X	X
	King	X	X	X	X	X	X	X	Х
	Smith	Х	X	X	X	X	X	X	Х
Cardiff	Griffin	X	X	X	X	X	X	X	X
	Hargrave	X	X	X	Х	X	X	X	Х
ATC	Cunningham	X	Х	X	Х	X	Х	X	Х
	Stobie	X	X	Х	Х	X	Х	X	X
MSSL	Brockley Blatt	X	X	X	X	X	X	X	х
CEA-SBT	Duband	X	X	X	X	X	Х	X	х
CEA-SAP	Cara	X	X	X	x	X	х	х	X
	Auguères	X	X	X	X	X	X	X	X
	Pinsard	X	X	X	X	X	X	X	Х
JPL	Bock	X	X	X	X	X	X	X	X
	Lilienthal	X	X	X	X	X	X	X	Х
	Hristov	X	X	X	x	X	х	X	X
LAM	Pouliquen	X	Х	X	Х	Х	х	X	Х
Can.	Taylor	X	X	X	x	X	x	X	Х
	Peterson	Х	X	X	X	X	Х	X	Х
ESA	Jackson	X	X	X	X	X	Х	X	X
	Heske	X	X	X	X	X	X	X	X
	Bruston	X	X	Х	X	X	Х	X	Х
CESR	Pons								
IFSI	Giorgio	X	X	X	X	X	X	X	X
	Orfei	X	X	х	Х	Х	х	X	Х
	Cerulli-Irelli	х	X	X	X	X	X	X	Х
ALCATEL	Lund	v	v	v	v	v	v	v	v
ALCATEL	Hibberd	X v	X V	X	X V	X	X v	X	X
Alenia	Cesa	X	X	X	X	X X	x x	X	X X
PA	Clark	х	Х	х	х	X	X	X	X

